Electronic Patent Application Fee Transmittal							
Application Number:	10560405						
Filing Date:	12-Dec-2005						
Title of Invention:	Method of bonding microstructured substrates						
First Named Inventor/Applicant Name:	Isabelle Chartier						
Filer:	Suvashis Bhattacharya/Monica Pizarro						
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U.S. National Stage under 35 USC 371 Filing	Fees						
Description	Fee Cod	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:				1			
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:				Ť			
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
	Tot	810		